

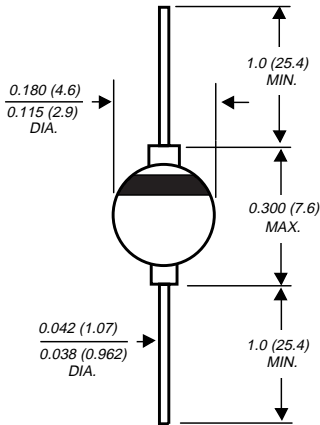
# BYV28-50 THRU BYV28-200

## GLASS PASSIVATED FAST EFFICIENT RECTIFIER

Reverse Voltage - 50 to 200 Volts    Forward Current - 3.5 Amperes

**PATENTED \***

Case Style G4



Dimensions in inches and (millimeters)

\* Brazed-lead assembly is covered by Patent No. 3,930,306

### FEATURES

- ◆ High temperature metallurgically bonded construction
- ◆ Glass passivated cavity-free junction
- ◆ Superfast recovery time for high efficiency
- ◆ Low forward voltage, high current capability
- ◆ Capable of meeting environmental standards of MIL-S-19500
- ◆ Hermetically sealed package
- ◆ Low leakage current
- ◆ High surge capability
- ◆ High temperature soldering guaranteed: 350°C/10 seconds, 0.375" (9.5mm) lead length, 5 lbs. (2.3kg) tension



### MECHANICAL DATA

**Case:** Solid glass body

**Terminals:** Plated axial leads, solderable per MIL-STD-750, Method 2026

**Polarity:** Color band denotes cathode end

**Mounting Position:** Any

**Weight:** 0.037 ounce, 1.04 grams

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

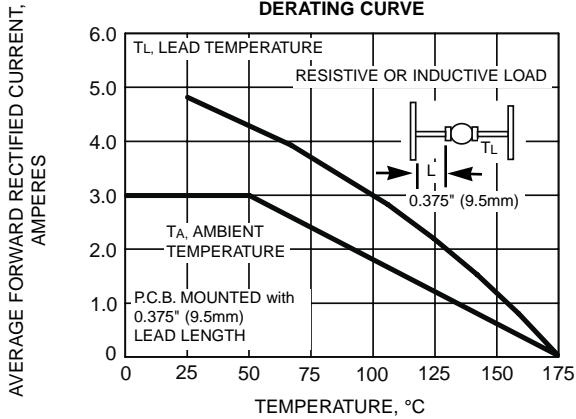
	SYMBOLS	BYV28-50	BYV28-100	BYV28-150	BYV28-200	UNITS
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	Volts
Maximum RMS voltage	$V_{RMS}$	35	70	105	140	Volts
Maximum DC blocking voltage	$V_{DC}$	50	100	150	200	Volts
Minimum reverse breakdown voltage at 100 $\mu$ A	$V_{(BR)}$	55	110	165	220	Volts
Maximum average forward rectified current 0.375" (9.5mm) lead length at $T_L=85^\circ\text{C}$	$I_{(AV)}$	3.5				Amps
Peak forward surge current 10ms single half sine-wave superimposed on rated load (JEDEC Method) at $T_J=175^\circ\text{C}$	$I_{FSM}$	90.0				Amps
Maximum instantaneous forward voltage at 3.5A $T_J=25^\circ\text{C}$ $T_J=175^\circ\text{C}$	$V_F$	1.1 0.89				Volts
Maximum DC reverse current at rated DC blocking voltage $T_A=25^\circ\text{C}$ $T_A=165^\circ\text{C}$	$I_R$	1.0 150.0				$\mu$ A
Maximum reverse recovery time (NOTE 1)	$t_{rr}$	30.0				ns
Typical junction capacitance (NOTE 2)	$C_J$	100.0				pF
Typical thermal resistance (NOTE 3, 4)	$R_{\theta JA}$ $R_{\theta JL}$	55.0 20.0				$^\circ\text{C/W}$
Operating junction and storage temperature range	$T_J, T_{STG}$	-65 to +175				$^\circ\text{C}$

**NOTES:**

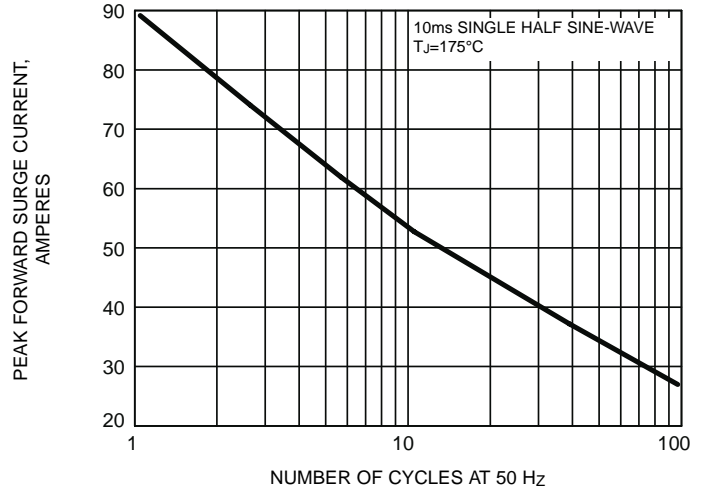
- (1) Reverse recovery test conditions:  $I_F=0.5\text{A}$ ,  $I_R=1.0\text{A}$ ,  $I_{rr}=0.25\text{A}$
- (2) Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts
- (3) Thermal resistance from junction to lead at 0.375" (9.5mm) lead length with both leads attached to heatsinks
- (4) Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length and mounted on P.C.B.

# RATINGS AND CHARACTERISTIC CURVES BYV28-50 THRU BYV28-200

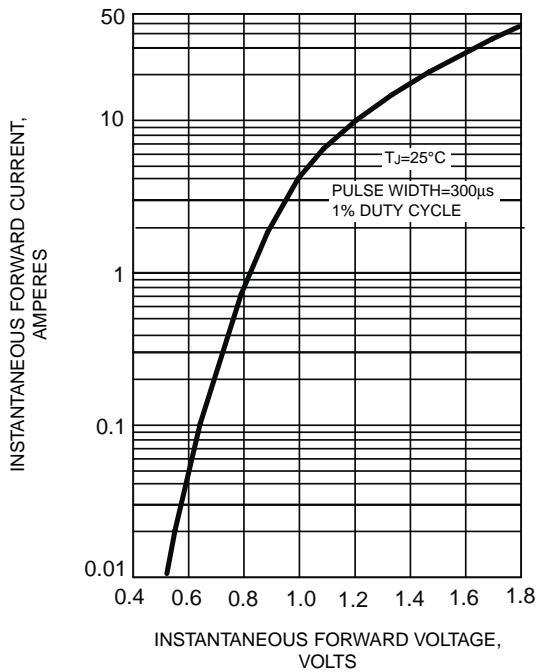
**FIG. 1 - MAXIMUM FORWARD CURRENT DERATING CURVE**



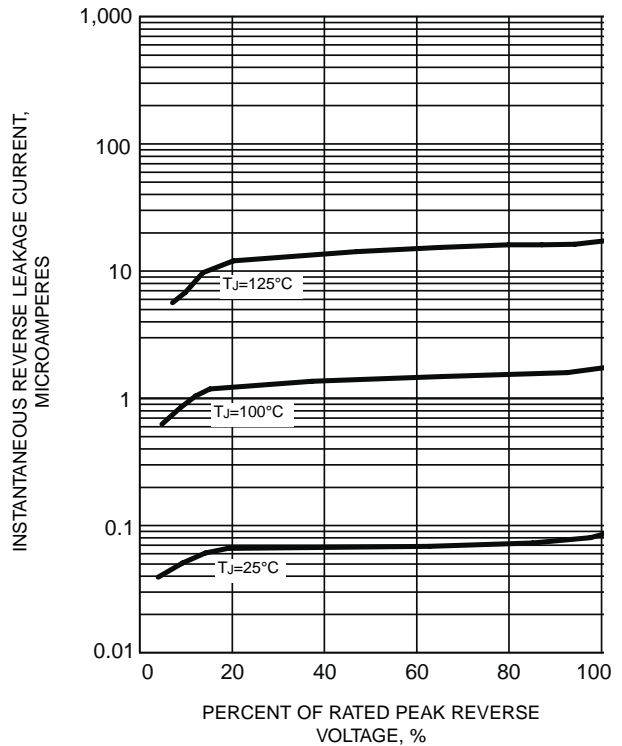
**FIG. 2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT**



**FIG. 3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS**



**FIG. 4 - TYPICAL REVERSE LEAKAGE CHARACTERISTICS**



**FIG. 5 - TYPICAL JUNCTION CAPACITANCE**

